onsemi

MOSFET - Power, Single N-Channel 100 V, 2.0 mΩ, 236 A NTMTSC002N10MC

Features

- Small Footprint (8x8 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- New Power 88 Dual Cool Package
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

			,			
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	100	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	۱ _D	236	А	
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		167		
Power Dissipation		$T_{C} = 25^{\circ}C$	PD	255	W	
R _{θJC} (Note 1)		T _C = 100°C		128		
Continuous Drain		$T_A = 25^{\circ}C$	۱ _D	29	А	
Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C		20		
Power Dissipation	State	$T_A = 25^{\circ}C$	PD	3.9	W	
R _{θJA} (Notes 1, 2)		T _A = 100°C		1.9		
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	А	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	213	А	
Single Pulse Drain–to–Source Avalanche Energy ($I_{L(pk)} = 18.2 \text{ A}$)			E _{AS}	2223	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

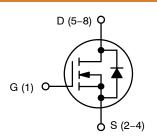
Parameter	Symbol	Value	Unit
Junction-to-Case, Bottom - Steady State	$R_{\theta JCB}$	0.6	°C/W
Junction-to-Case, Top - Steady State	$R_{\theta JCT}$	0.9	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	38	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
100 V	2.0 mΩ @ 10 V	236 A

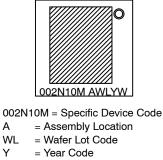


N-CHANNEL MOSFET



CASE 507AN

MARKING DIAGRAM



W = Work Week Code

ORDERING INFORMATION

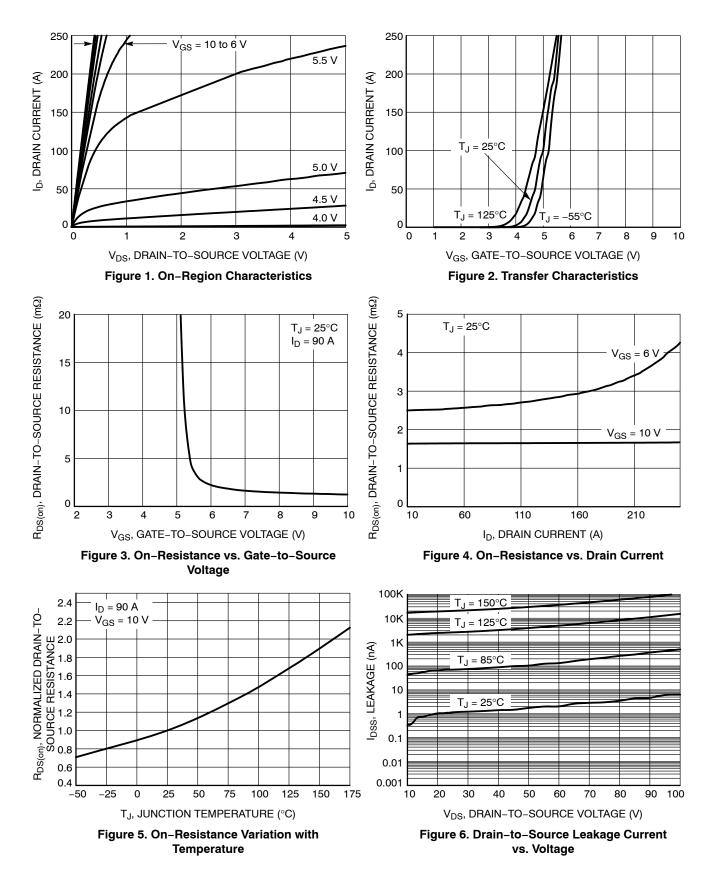
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

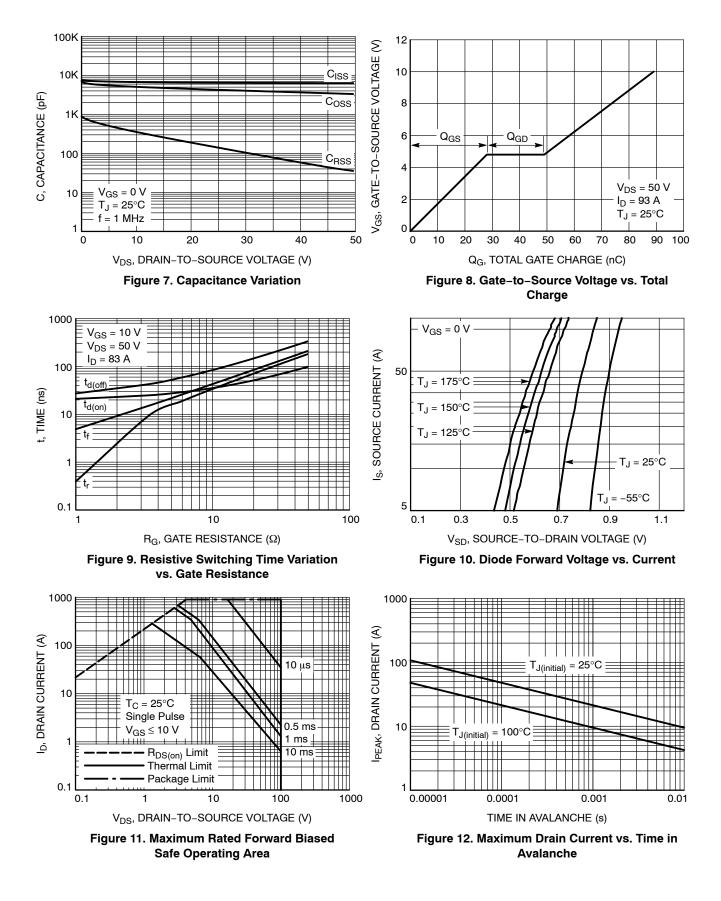
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		100			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				68.7		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			5	μΑ	
		V _{DS} = 100 V	T _J = 125°C			10		
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_G$	_S = 20 V			100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 520 μA	2.0		4.0	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-9.86		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 6 V	I _D = 46 A			5.3	mΩ	
		V _{GS} = 10 V	I _D = 90 A		1.7	2.0		
Forward Transconductance	9 _{FS}	V _{DS} =5 V, I _D	₀ = 93 A		180		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 50 V			6305		pF	
Output Capacitance	C _{OSS}				3405			
Reverse Transfer Capacitance	C _{RSS}			37				
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 50 V; I _D = 93 A			89			
Threshold Gate Charge	Q _{G(TH)}				17		nC	
Gate-to-Source Charge	Q _{GS}			28				
Gate-to-Drain Charge	Q _{GD}	V _{GS} = 10 V, V _{DS} =		21				
Plateau Voltage	V _{GP}	1			4.8		V	
SWITCHING CHARACTERISTICS (Note \$	5)							
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 50 V, I_{D} = 93 A, R_{G} = 6 Ω			29		- ns	
Rise Time	t _r				19			
Turn-Off Delay Time	t _{d(OFF)}				59			
Fall Time	t _f				26			
DRAIN-SOURCE DIODE CHARACTERIS	STICS							
Forward Diode Voltage	V _{SD}	$V_{CC} = 0 V_{c}$	$T_J = 25^{\circ}C$		0.84	1.2		
		V _{GS} = 0 V, I _S = 90 A	T _J = 125°C		0.72		- V	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 46 A			49			
Charge Time	t _a				24		ns	
Discharge Time	t _b				26			
Reverse Recovery Charge	Q _{RR}				44		nC	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 1000 A/μs, I _S = 46 A			38		ns	
Charge Time	t _a				21			
Discharge Time	t _b				18			
Reverse Recovery Charge	Q _{RR}				310		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures. niess otherwise noted. Produci

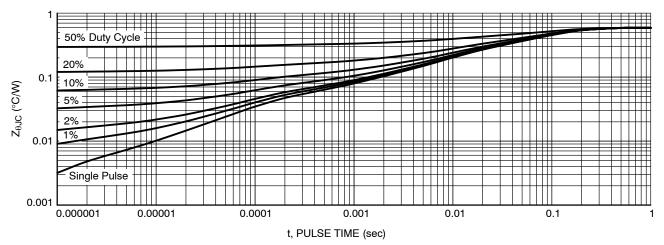
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMTSC002N10MCTXG	002N10M	POWER 88 Dual Cool (Pb–Free)	3,000 / Tape & Reel

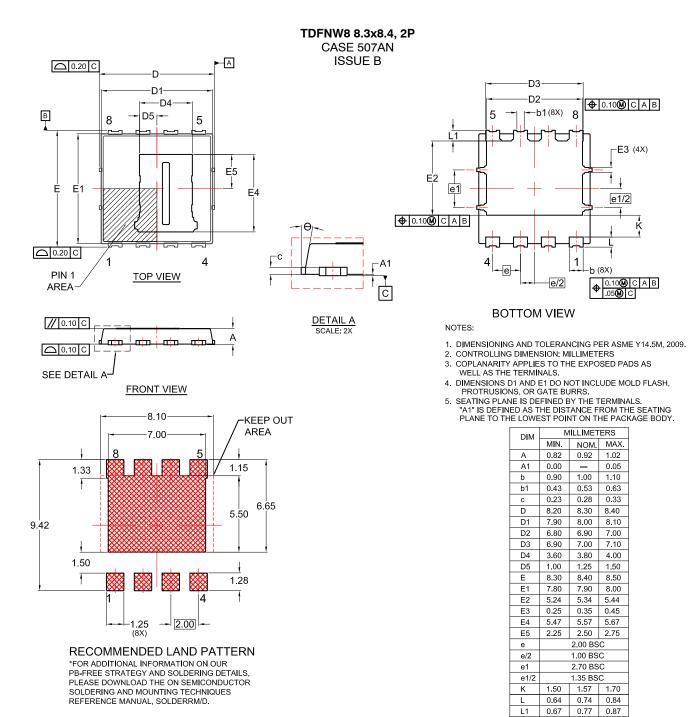
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

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